

# **PLCC Series**

# 2835 0.5W Plant Lighting

# Datasheet



#### Introduction:

Ultra high luminous efficacy, combined with the flexibility in design due to its slim and miniature size, PLCC LED Series are optimized to be used as lighting for building.

### **I** Description:

- · Best luminous and color uniformity
- · Enables halogen and CDM replacement
- · The article itself presents the actual color.

#### | Feature and Benefits:

- · Based on Blue: InGaN, Red: AlGaInP technology
- · Wide viewing angle: 120°
- · Excellent performance and visibility
- · Suitable for all SMT assembly methods
- · IR reflow process compatible
- · Environmental friendly; RoHS compliance



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#### **General Information**

### **Ordering Code Format**

	X1		X2	X3	3-X4	X5	5-X6		X7-X8
7	Гуре	Com	ponent	Se	eries	Wat	ttage	Co	olor/CCT
2	Emitter	Т	PLCC	03	3528	X5	0.5W	BX	Blue
								EX	Deep Red
								FX	Cherry Red

Х9	X9 X10-X11		X14-X16
BIN CRI		Voltage	Serial Number
Χ -	00 -	03 3V	



#### **Absolute Maximum Ratings**

Absolute maximum ratings  $(T_a=25^{\circ}C)$ 

Parameter	Symbol	Value	Units
DC Forward Current	I <sub>F</sub>	200	mA
Pulse Forward Current (tp<=100µs, Duty cycle=0.25)	<b>I</b> <sub>pulse</sub>	400	mA
Reverse Current	$I_R$	10	uA
Reverse Voltage	$V_R$	5	V
LED Junction Temperature	T,	125	°C
Operating Temperature	-	-40 ~ +85	°C
Storage Temperature	-	-40 ~ +125	°C
ESD Sensitivity (HBM)	-	2,000	V
Soldering Temperature	T <sub>s</sub> Reflow Soldering : 255~260°C/10~30sec Manual Soldering : 350°C/3sec		

- 1. Proper current derating must be observed to maintain junction temperature below the maximum at all time.
- 2. LEDs are not designed to be driven in reverse bias.
- 3. tp: Pulse width time

#### **Characteristics**

Parameter		Symbol	Value	Units
Viewing Angle	(Typ.)	$2\Theta_{\text{1/2}}$	130	Degree
Thermal resistance		-	10	°C/W
Wavelength	(Blue) (Deep Red) (Cherry Red)	-	450-460 650-670 720-740	nm
JEDEC Moisture Sensitivity		-	Level 2a Floor Life Conditions: ≤30°C / 60% RH Soak Requirements(Standard) Time (hours): 120+1/-0 Conditions: 60°C / 60% RH	-

#### Note:

 $2\theta_{\scriptscriptstyle{1/2}}$  is the off-axis angle where the luminous intensity is half of the axial luminous intensity.



#### **Luminous Flux Characteristic**

Luminous Flux Characteristics,  $I_F=150$ mA,  $V_F=5$ V and  $T_J=25$ °C

Color	Group	Min. Radiometric Power(mW) @150mA	Max. Radiometric Power(mW) @150mA	Order Code
	B1	130.0	169.0	
Blue	B2	169.0	219.7	2T03X5BXX0003001
	В3	219.7	285.6	
	R2	84.5	109.8	
Deep Red	R3	109.8	142.8	2T03X5EXX0003001
	R4	142.8	185.6	
	R0	50.0	65.0	
Cherry Red	R1	65.0	84.5	2T03X5FXX0003001
	R2	84.5	109.8	

The luminous flux performance is guaranteed within published operating conditions. Edison Opto maintains a tolerance of  $\pm 10\%$  on flux measurements.

### **Wavelength Bin Structure**

Color Group		Min. Wd (nm)	Max. Wd (nm)
Blue	BUO	450	455
	BV0	455	460
Deep Red	EX0	650	670
Cherry Red	FX1	720	740

Dominant wavelength Measurement Allowance is  $\pm 1$ nm.



# **Voltage Bin Structure**

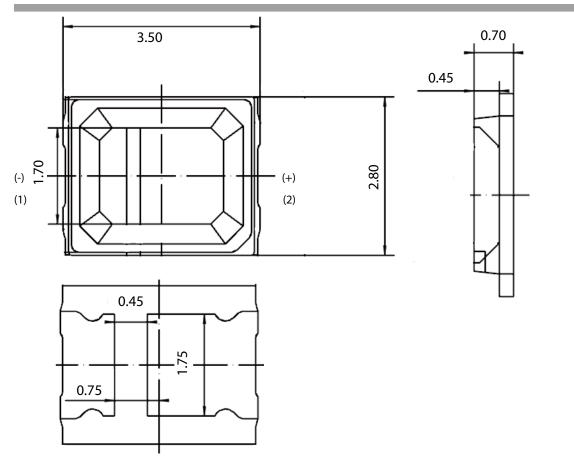
Color	Group	Min. Voltage (V)	Max. Voltage (V)
	VB1	2.9	3.0
	VC1	3.0	3.1
Blue	VA2	3.1	3.2
	VB2	3.2	3.3
	VC2	3.3	3.4
	UC3	1.8	1.9
	UA4	1.9	2.0
	UB4	2.0	2.1
Deep Red	UC4	2.1	2.2
	UA5	2.2	2.3
	UB5	2.3	2.4
	UC5	2.4	2.5
	UC3	1.8	1.9
	UA4	1.9	2.0
	UB4	2.0	2.1
Cherry Red	UC4	2.1	2.2
	UA5	2.2	2.3
	UB5	2.3	2.4
	UC5	2.4	2.5

Note:

Forward voltage measurement allowance is  $\pm\,0.06$ V.

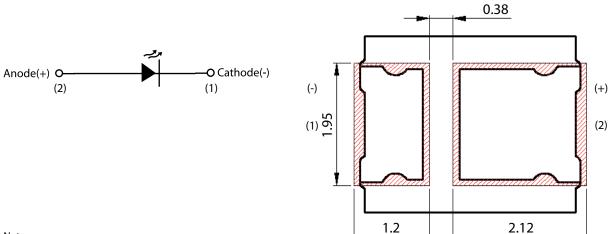


#### **Mechanical Dimensions**



#### Circuit

#### **Solder Pad**



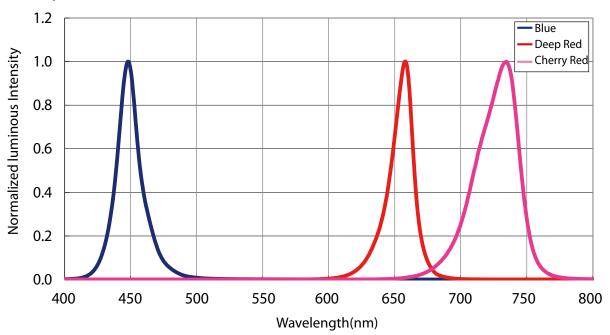
#### Notes:

- 1. All dimensions are measured in mm.
- 2. Tolerance :  $\pm$  0.20 mm

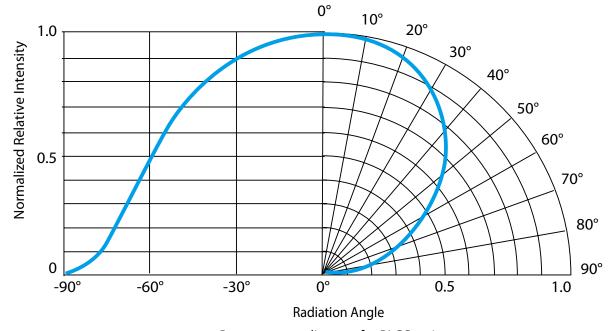


#### **Characteristic curve**

#### **Color Spectrum**



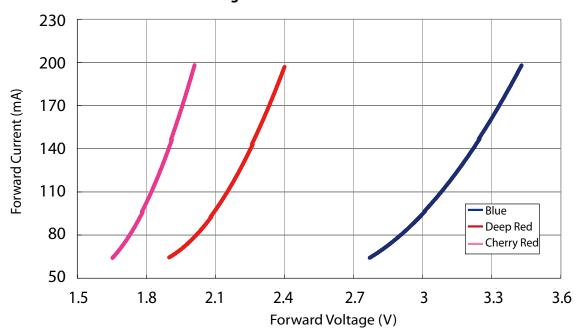
#### **Beam Pattern**



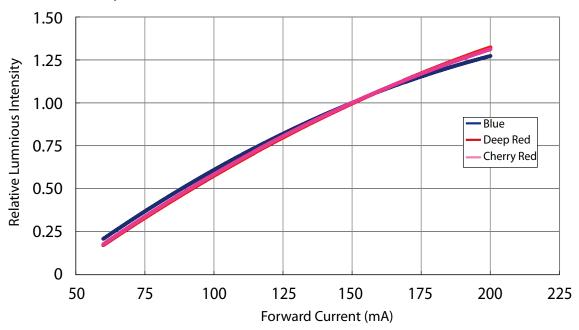
Beam pattern diagram for PLCC series



#### **Forward Current vs. Forward Voltage**

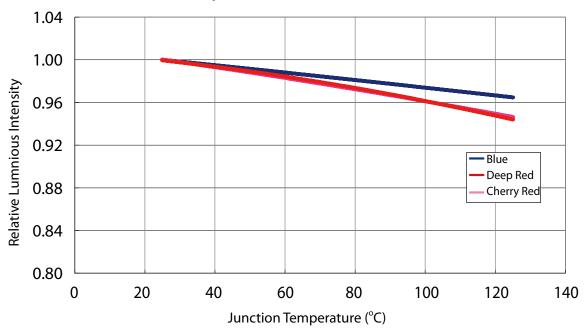


#### **Relative Intensity vs. Forward Current**

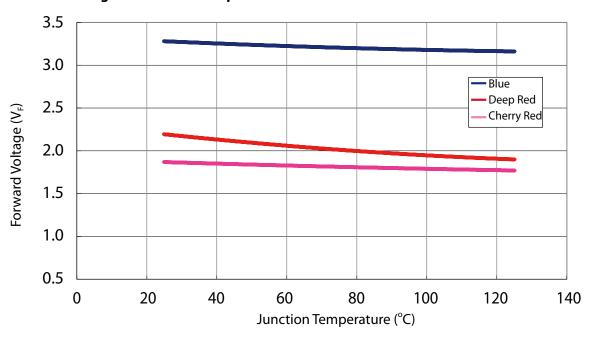




#### **Luminous Flux vs. Junction Temperature**

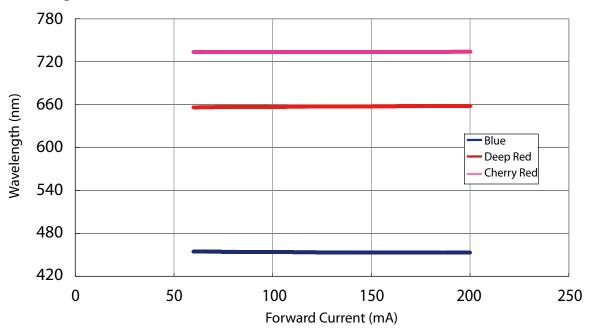


#### Forward Voltage vs. Junction Temperature

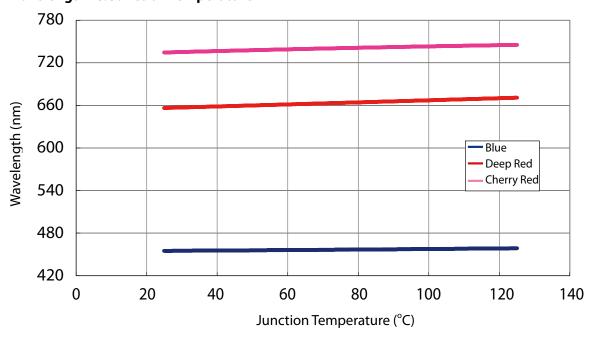




#### **Wavelength vs. Forward Current**

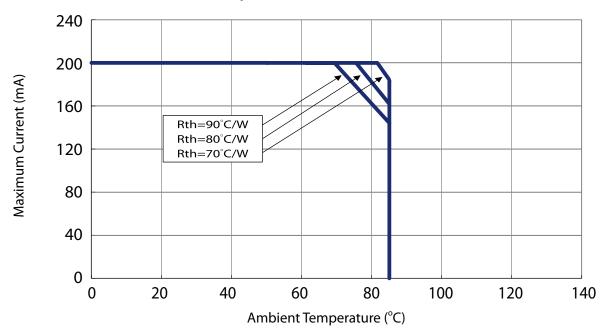


#### **Wavelength vs. Junction Temperature**

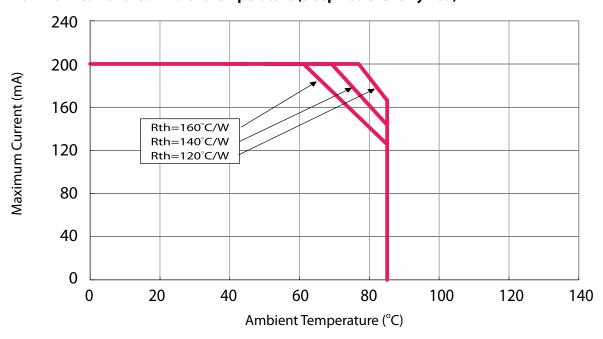




#### **Maximum Current vs. Ambient Temperature (Blue)**



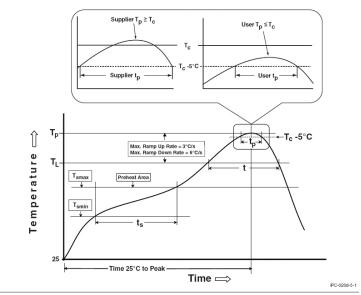
#### Maximum Current vs. Ambient Temperature (Deep Red & Cherry Red)





#### **Reflow Profile**

The following reflow profile is from IPC/JEDEC J-STD-020D which provided here for reference.



**Reflow Profiles** 

#### **Classification Reflow Profiles**

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150 °C 200 °C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3 °C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217 °C 60-150 seconds
Peak package body temperature (Tp)*	255 °C ~260 °C *
Classification temperature (Tc)	260 °C
Time (tp)** within 5 °C of the specified classification temperature (Tc)	30** seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

#### Notes:

- 1. \* Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.
- 2. \*\* Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.



## Reliability

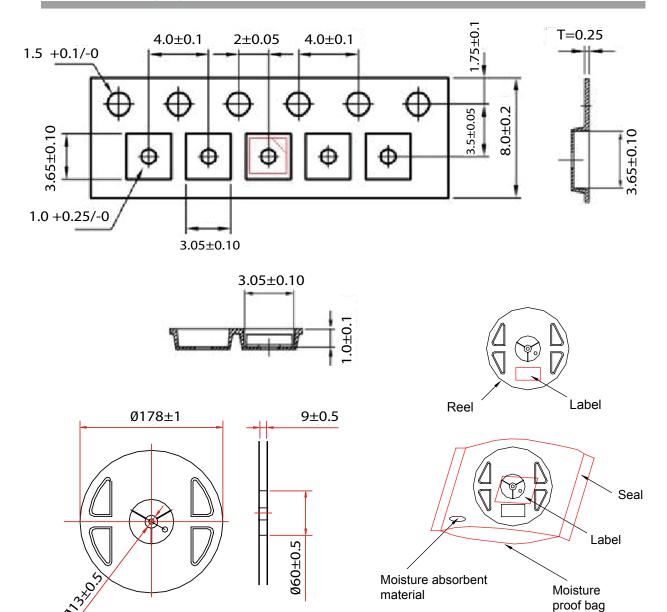
NO.	Test Item	Test Condition	Remark
1	Temperature Cycle	-40°C~100°C 30, 30, mins	100 Cycle
2	Thermal Shock	-40°C~100°C 15, 15 mins ≦ 10 sec	100 Cycle
3	Resistance to Soldering Heat	T <sub>SOL</sub> =260°C, 30 sec	3 times
4	Moisture Resistance	25°C~65°C 90% RH 24 hrs / 1 cycle	10 Cycle
5	High-Temperature Storage	T <sub>A</sub> =100°C	1,000 hrs
6	Humidity Heat Storage	T <sub>A</sub> =85°C RH=85%	1,000 hrs
7	Low-Temperature Storage	$T_A=-40$ °C	1,000 hrs
8	Operation Life test	25°C	1,000 hrs
9	High Temperature Operation Life test	85°C	1,000 hrs
10	High Humidity Heat Life Test	85°C, 85%RH	1,000 hrs
11	ON/OFF Test	30 sec ON, 30 sec OFF	1.5W times

#### **Failure Criteria**

Item	Criteria for Judgment			
item	Min.	Max.		
Lumen Maintenance	85%	-		
<b>∆</b> u'∨'	-	0.006		
Forward Voltage	-	Initial Data x 1.1		
Reverse Current	-	10 μΑ		
Resistance to Soldering Heat	No dead lamps or visual damage			



### **Product Packaging Information**



ltem	Quantity	Total	Dimensions(mm)			
Reel	4,000pcs	4,000pcs	R=178			
Starting with 150pcs empty, and 150pcs empty at the last						



#### **Revision History**

Versions	Description	Release Date
1	Establish a Datasheet	2016/08/08

#### **About Edison Opto**

Edison Opto is a leading manufacturer of high power LED and a solution provider experienced in LDMS. LDMS is an integrated program derived from the four essential technologies in LED lighting applications- Thermal Management, Electrical Scheme, Mechanical Refinement, Optical Optimization, to provide customer with various LED components and modules. More Information about the company and our products can be found at www.edison-opto.com

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